COMPLIANT

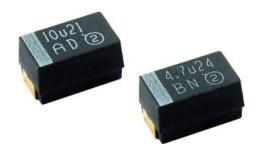
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(5-2008)



# Solid Tantalum Surface Mount Chip Capacitors TANTAMOUNT™, Molded Case, HI-TMP®, Very High Temperature 200 °C



# PERFORMANCE / ELECTRICAL CHARACTERISTICS

Operating Temperature: -55 °C to +200 °C Capacitance Range: 4.7  $\mu$ F to 100  $\mu$ F Capacitance Tolerance:  $\pm$  10 %,  $\pm$  20 %

Voltage Range: 5 V<sub>DC</sub> to 24 V<sub>DC</sub>

#### **FEATURES**

- Operating temperature up to +200 °C
- Category voltage at +200 °C: same as rated voltage (RV) at 25 °C to 85 °C
- 500 h continuous operation at RV
- Gold plated terminations
- 100 % surge current tested
- Standard EIA 535BAAC case sizes
- Moisture sensitivity level 1
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

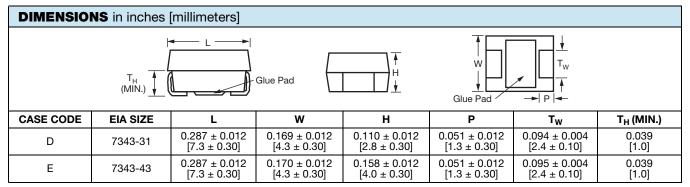
#### **APPLICATIONS**

- Oil and petroleum
- · High temperature sensing and drilling systems
- Industrial
- Safety critical industrial tools and products
- · High temperature extended activities
- High temperature engines
- · Electronic sensors

ORDERING INFORMATION						
TH5	E	106	K	021	В	1000
TYPE	CASE CODE L See Ratings and Case Codes table	This is expressed in picofarads. The first two digits are the significant figures. The third is the number of zeros to follow.	CAPACITANCE TOLERANCE     K = ± 10 %   M = ± 20 %	CATEGORY VOLTAGE AT -55 °C TO +200 °C  This is expressed in V. To complete the three-digit block, zeros precede the voltage rating.	TERMINATION / PACKAGING	$\begin{tabular}{ c c c c c }\hline ESR\\ \hline & & & \\ \hline & & \\ \hline & & \\ \hline & & \\ \hline & & & \\ \hline &$

#### Note

(1) Other termination on request



#### Note

Glue pad (non-conductive, part of molded case) is dedicated for glue attachment (as user option).

#### Note

TH5 series capacitors have been designed for, and tested at category voltage at +200 °C for 500 h.
 As with all Tantalum capacitors, reliability and life time may be extended by application of lower voltage.



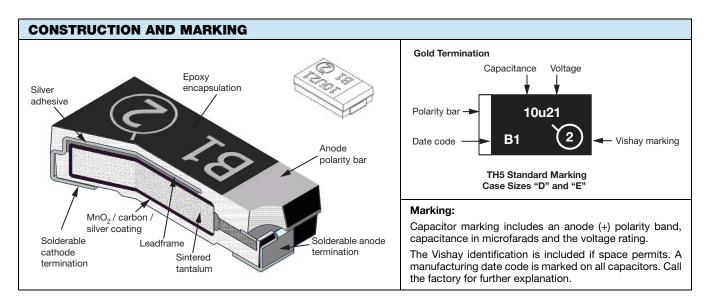
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RATINGS AND CASE CODES					
μF	5 <b>V</b>	8 V	21 V	24 V	
4.7				E (2.50)	
10			E (1.00, 0.50)		
22		D (0.50), E (0.50)			
100	E (0.25)				

#### Note

• ESR limit (in  $\Omega$ ) is shown in parenthesis.



STANDARD RATINGS							
CAPACITANCE (µF)	CASE CODE	PART NUMBER	MAX. DCL AT +25 °C (μA)	TYPICAL DCL AT +200 °C (μΑ)	MAX. DF AT +25 °C (%)	MAX. ESR AT +25 °C 100 kHz (Ω)	MAX. RIPPLE 100 kHz I <sub>RMS</sub> (A)
			5 V <sub>DC</sub> AT +20	00 °C			
100	Е	TH5E107(1)005(2)0250	5.0	300	8	0.250	0.81
			8 V <sub>DC</sub> AT +20	00 °C			
22	D	TH5D226(1)008(2)0500	6.0	360	6	0.500	0.55
22	Е	TH5E226(1)008(2)0500	6.0	360	6	0.500	0.57
			21 V <sub>DC</sub> AT +2	00 °C			
10	Е	TH5E106(1)021(2)1000	2.1	120	6	1.000	0.41
10	Е	TH5E106(1)021(2)0500	2.1	120	6	0.500	0.57
	24 V <sub>DC</sub> AT +200 °C						
4.7	Е	TH5E475(1)024(2)2500	1.1	60	10	2.500	0.26

#### Note

- Part number definitions:
  - (1) Capacitance tolerance codes: K, M
  - (2) Terminations and packaging: A, B, G, Q

STANDARD PACKAGING QUANTITY					
CASE CODE	UNITS PER REEL				
CASE CODE	13" FULL REEL	7" FULL REEL	7" HALF REEL	7" PARTIAL REEL	
D	2500	500	250	100	
E	1500	400	200	100	

#### Note

TH5 series capacitors have been designed for, and tested at category voltage at +200 °C for 500 h. As with all Tantalum capacitors, reliability and life time may be extended by application of lower voltage.



### **Guide for Molded Tantalum Capacitors**

#### INTRODUCTION

Tantalum electrolytic capacitors are the preferred choice in applications where volumetric efficiency, stable electrical parameters, high reliability, and long service life are primary considerations. The stability and resistance to elevated temperatures of the tantalum / tantalum oxide / manganese dioxide system make solid tantalum capacitors an appropriate choice for today's surface-mount assembly technology.

Vishay Sprague has been a pioneer and leader in this field, producing a large variety of tantalum capacitor types for consumer, industrial, automotive, military, and aerospace electronic applications.

Tantalum is not found in its pure state. Rather, it is commonly found in a number of oxide minerals, often in combination with Columbium ore. This combination is known as "tantalite" when its contents are more than one-half tantalum. Important sources of tantalite include Australia, Brazil, Canada, China, and several African countries. Synthetic tantalite concentrates produced from tin slags in Thailand, Malaysia, and Brazil are also a significant raw material for tantalum production.

Electronic applications, and particularly capacitors, consume the largest share of world tantalum production. Other important applications for tantalum include cutting tools (tantalum carbide), high temperature super alloys, chemical processing equipment, medical implants, and military ordnance.

Vishay Sprague is a major user of tantalum materials in the form of powder and wire for capacitor elements and rod and sheet for high temperature vacuum processing.

#### THE BASICS OF TANTALUM CAPACITORS

Most metals form crystalline oxides which are non-protecting, such as rust on iron or black oxide on copper. A few metals form dense, stable, tightly adhering, electrically insulating oxides. These are the so-called "valve" metals and include titanium, zirconium, niobium, tantalum, hafnium, and aluminum. Only a few of these permit the accurate control of oxide thickness by electrochemical means. Of these, the most valuable for the electronics industry are aluminum and tantalum.

Capacitors are basic to all kinds of electrical equipment, from radios and television sets to missile controls and automobile ignitions. Their function is to store an electrical charge for later use.

Capacitors consist of two conducting surfaces, usually metal plates, whose function is to conduct electricity. They are separated by an insulating material or dielectric. The dielectric used in all tantalum electrolytic capacitors is tantalum pentoxide.

Tantalum pentoxide compound possesses high-dielectric strength and a high-dielectric constant. As capacitors are being manufactured, a film of tantalum pentoxide is applied to their electrodes by means of an electrolytic process. The film is applied in various thicknesses and at various voltages and although transparent to begin with, it takes on different colors as light refracts through it. This coloring occurs on the tantalum electrodes of all types of tantalum capacitors.

Rating for rating, tantalum capacitors tend to have as much as three times better capacitance / volume efficiency than aluminum electrolytic capacitors. An approximation of the capacitance / volume efficiency of other types of capacitors may be inferred from the following table, which shows the dielectric constant ranges of the various materials used in each type. Note that tantalum pentoxide has a dielectric constant of 26, some three times greater than that of aluminum oxide. This, in addition to the fact that extremely thin films can be deposited during the electrolytic process mentioned earlier, makes the tantalum capacitor extremely efficient with respect to the number of microfarads available per unit volume. The capacitance of any capacitor is determined by the surface area of the two conducting plates, the distance between the plates, and the dielectric constant of the insulating material between the plates.

COMPARISON OF CAPACITOR DIELECTRIC CONSTANTS		
DIELECTRIC	e DIELECTRIC CONSTANT	
Air or vacuum	1.0	
Paper	2.0 to 6.0	
Plastic	2.1 to 6.0	
Mineral oil	2.2 to 2.3	
Silicone oil	2.7 to 2.8	
Quartz	3.8 to 4.4	
Glass	4.8 to 8.0	
Porcelain	5.1 to 5.9	
Mica	5.4 to 8.7	
Aluminum oxide	8.4	
Tantalum pentoxide	26	
Ceramic	12 to 400K	

In the tantalum electrolytic capacitor, the distance between the plates is very small since it is only the thickness of the tantalum pentoxide film. As the dielectric constant of the tantalum pentoxide is high, the capacitance of a tantalum capacitor is high if the area of the plates is large:

$$C = \frac{eA}{t}$$

where

C = capacitance

e = dielectric constant

A = surface area of the dielectric

t = thickness of the dielectric

Tantalum capacitors contain either liquid or solid electrolytes. In solid electrolyte capacitors, a dry material (manganese dioxide) forms the cathode plate. A tantalum lead is embedded in or welded to the pellet, which is in turn connected to a termination or lead wire. The drawings show the construction details of the surface-mount types of tantalum capacitors shown in this catalog.



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#### SOLID ELECTROLYTE TANTALUM CAPACITORS

Solid electrolyte capacitors contain manganese dioxide, which is formed on the tantalum pentoxide dielectric layer by impregnating the pellet with a solution of manganous nitrate. The pellet is then heated in an oven, and the manganous nitrate is converted to manganese dioxide.

The pellet is next coated with graphite, followed by a layer of metallic silver, which provides a conductive surface between the pellet and the leadframe.

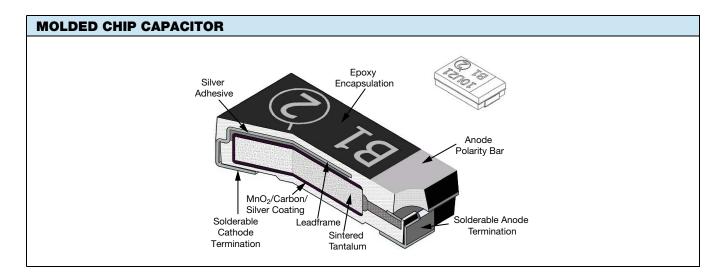
Molded Chip tantalum capacitor encases the element in plastic resins, such as epoxy materials. The molding compound has been selected to meet the requirements of UL 94 V-0 and outgassing requirements of ASTM E-595. After assembly, the capacitors are tested and inspected to assure long life and reliability. It offers excellent reliability and high stability for consumer and commercial electronics with the added feature of low cost

Surface-mount designs of "solid tantalum" capacitors use lead frames or lead frameless designs as shown in the accompanying drawings.

# TANTALUM CAPACITORS FOR ALL DESIGN CONSIDERATIONS

Solid electrolyte designs are the least expensive for a given rating and are used in many applications where their very small size for a given unit of capacitance is of importance. They will typically withstand up to about 10 % of the rated DC working voltage in a reverse direction. Also important are their good low temperature performance characteristics and freedom from corrosive electrolytes.

Vishay Sprague patented the original solid electrolyte capacitors and was the first to market them in 1956. Vishay Sprague has the broadest line of tantalum capacitors and has continued its position of leadership in this field. Data sheets covering the various types and styles of Vishay Sprague capacitors for consumer and entertainment electronics, industry, and military applications are available where detailed performance characteristics must be specified.





#### **COMMERCIAL PRODUCTS**

SOLID TANTA	SOLID TANTALUM CAPACITORS - MOLDED CASE					
SERIES	293D	793DX-CTC3- CTC4	593D	TR3	TP3	TL3
PRODUCT IMAGE	In the last lines lines	In the line lines	***************************************		150 FE	1800 (S)
TYPE		Surface-m	ount Tantamount™, i	molded case		
FEATURES	Standard industrial grade	CECC approved	Low ESR	Low ESR	High performance, automotive grade	Very low DCL
TEMPERATURE RANGE			-55 °C to -	+125 °C		
CAPACITANCE RANGE	0.1 μF to 1000 μF	0.1 μF to 100 μF	1 μF to 470 μF	0.47 μF to 1000 μF	0.1 μF to 470 μF	0.1 μF to 470 μF
VOLTAGE RANGE	4 V to 75 V	4 V to 50 V	4 V to 50 V	4 V to 75 V	4 V to 50 V	4 V to 50 V
CAPACITANCE TOLERANCE		± 10 %, ± 20 %				
LEAKAGE CURRENT	0.005 CV or 0.25 μA, whichever is greater 0.25 μA, whichever is greater				0.25 µA, whichever is	
DISSIPATION FACTOR	4 % to 30 %	4 % to 6 %	4 % to 15 %	4 % to 30 %	4 % to 15 %	4 % to 15 %
CASE CODES	A, B, C, D, E	A, B, C, D	A, B, C, D, E	A, B, C, D, E, W	A, B, C, D, E	A, B, C, D, E
TERMINATION		10	00 % matte tin standa	rd, tin / lead available	,	

SOLID TANTA	SOLID TANTALUM CAPACITORS - MOLDED CASE					
SERIES	TX3	TH3	TH4	TH5		
PRODUCT IMAGE	33 X 2 @	1575 1575	The state of the s	Bus &		
TYPE		Surface-mount TANTAN	MOUNT™, molded case			
FEATURES	E-detonators	High temperature +150 °C, automotive grade	High temperature +175 °C, automotive grade	Very high temperature +200 °C		
TEMPERATURE RANGE	-55 °C to +125 °C	-55 °C to +150 °C	-55 °C to +175 °C	-55 °C to +200 °C		
CAPACITANCE RANGE	10 μF to 100 μF	0.33 μF to 220 μF	10 μF to 100 μF	4.7 μF to 100 μF		
VOLTAGE RANGE	16 V to 25 V	6.3 V to 50 V	6.3 V to 35 V	5 V to 24 V		
CAPACITANCE TOLERANCE		± 10 %, ± 20 %				
LEAKAGE CURRENT	0.005 CV	0.01 CV or 0.5 μA, whichever is greater				
DISSIPATION FACTOR	6 % to 20 %	4 % to 8 %	4.5 % to 8 %	6 % to 10 %		
CASE CODES	B, C	A, B, C, D, E	B, C, D, E	D, E		
TERMINATION	100 % matte tin	100 % matte tin standard, tin / lead and gold plated available	100 % matte tin	Gold plated		



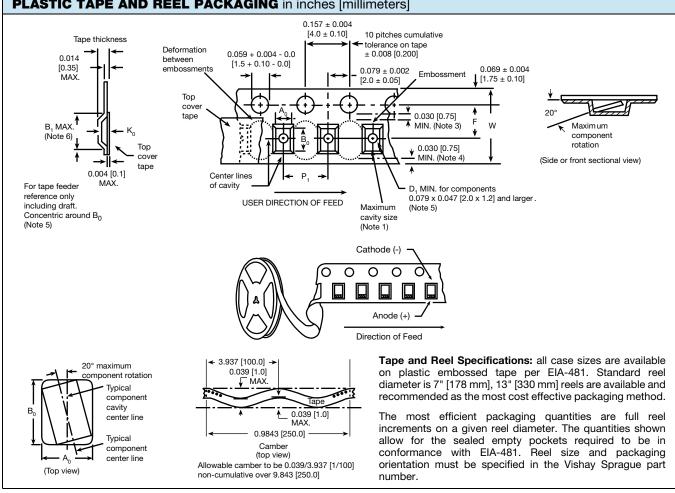
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#### **HIGH RELIABILITY PRODUCTS**

SOLID TANTA	LUM CAPACITORS - MC	LDED CASE			
SERIES	тмз	T83	CWR11	95158	
PRODUCT IMAGE	The o	47716 20 6			
ТҮРЕ	TANTAMOUNT™, molded case, hi-rel.	TANTAMOUNT™, molded case, hi-rel. COTS	Tantamount™ DLA ap		
FEATURES	High reliability, for medical Instruments	High reliability, standard and low ESR	MIL-PRF-55365/8 qualified	Low ESR	
TEMPERATURE RANGE		-55 °C to +125 °C			
CAPACITANCE RANGE	1 μF to 220 μF	0.1 μF to 470 μF	μF 0.1 μF to 100 μF 4.7 μF to 2		
VOLTAGE RANGE	4 V to 20 V	4 V to 63 V	4 V to 50 V		
CAPACITANCE TOLERANCE	± 10 %, ± 2	20 %	± 5 %, ± 10 %, ± 20 %	± 10 %, ± 20 %	
LEAKAGE CURRENT	0.005 CV or 0.25 μA, whichever is greater	0.0	1 CV or 0.5 μA, whichever is g	greater	
DISSIPATION FACTOR	4 % to 8 %	4 % to 15 % 4 % to 6 %		4 % to 12 %	
CASE CODES	A, B, C, D, E	A, B, C, D, E	A, B, C, D	C, D, E	
TERMINATION 100 % matte tin; 100 % matte tin; tin / lead;		Tin / lead; tin / lead solder fused	Tin / lead solder plated; gold plated		

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#### Notes

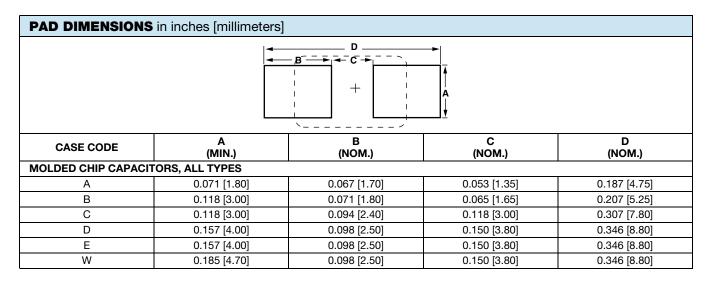
- Metric dimensions will govern. Dimensions in inches are rounded and for reference only
- (1) A<sub>0</sub>, B<sub>0</sub>, K<sub>0</sub>, are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A<sub>0</sub>, B<sub>0</sub>, K<sub>0</sub>) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°
- (2) Tape with components shall pass around radius "R" without damage. The minimum trailer length may require additional length to provide "R" minimum for 12 mm embossed tape for reels with hub diameters approaching N minimum
- (3) This dimension is the flat area from the edge of the sprocket hole to either outward deformation of the carrier tape between the embossed cavities or to the edge of the cavity whichever is less
- (4) This dimension is the flat area from the edge of the carrier tape opposite the sprocket holes to either the outward deformation of the carrier tape between the embossed cavity or to the edge of the cavity whichever is less
- (5) The embossed hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location shall be applied independent of each other
- (6) B<sub>1</sub> dimension is a reference dimension tape feeder clearance only

CASE CODE	TAPE SIZE	B <sub>1</sub> (MAX.)	D <sub>1</sub> (MIN.)	F	K <sub>0</sub> (MAX.)	P <sub>1</sub>	w
MOLDED	CHIP CAPA	CITORS; ALL TY	/PES				
Α	8 mm	0.165	0.039	0.138 ± 0.002	0.094	0.157 ± 0.004	0.315 ± 0.012
В	0 111111	[4.2]	[1.0]	$[3.5 \pm 0.05]$	[2.4]	$[4.0 \pm 1.0]$	$[8.0 \pm 0.30]$
С							
D	12 mm	0.32	0.059	$0.217 \pm 0.00$	0.177	$0.315 \pm 0.004$	$0.472 \pm 0.012$
Е	12 111111	[8.2]	[1.5]	$[5.5 \pm 0.05]$	[4.5]	$[8.0 \pm 1.0]$	$[12.0 \pm 0.30]$
W							



#### RECOMMENDED REFLOW PROFILES Capacitors should withstand reflow profile as per J-STD-020 standard, three cycles. T<sub>C</sub> - 5 °C Max. ramp-up rate = 3 °C/s Max. ramp-down rate = 6 °C/s remperature (°C) Preheat area T<sub>s min.</sub> 25 Time 25 °C to peak TIME (s) **PROFILE FEATURE** SnPb EUTECTIC ASSEMBLY **LEAD (Pb)-FREE ASSEMBLY** Preheat / soak Temperature min. (T<sub>s min.</sub>) 100 °C 150 °C Temperature max. (T<sub>s max.</sub>) 150 °C 200 °C Time $(t_s)$ from $(T_{s min.} to T_{s max.})$ 60 s to 120 s 60 s to 120 s Ramp-up Ramp-up rate (T<sub>L</sub> to T<sub>D</sub>) 3 °C/s max. 3 °C/s max. 217 °C 183 °C Liquidus temperature (T<sub>L</sub>) Time (t<sub>1</sub>) maintained above T<sub>1</sub> 60 s to 150 s 60 s to 150 s Peak package body temperature (Tp) Depends on case size - see table below Time (t<sub>p</sub>) within 5 °C of the specified classification temperature (T<sub>C</sub>) 20 s 30 s Time 25 °C to peak temperature 6 min max. 8 min max. Ramp-down Ramp-down rate (Tp to TL) 6 °C/s max. 6 °C/s max.

PEAK PACKAGE BODY TEMPERATURE (Tp)			
CASE CODE	PEAK PACKAGE BODY TEMPERATURE (Tp)		
CASE CODE	SnPb EUTECTIC PROCESS	LEAD (Pb)-FREE PROCESS	
A, B, C	235 °C	260 °C	
D, E, W	220 °C	250 °C	



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#### **GUIDE TO APPLICATION**

 AC Ripple Current: the maximum allowable ripple current shall be determined from the formula:

$$I_{RMS} = \sqrt{\frac{P}{R_{ESR}}}$$

where,

P = power dissipation in W at +25 °C as given in the tables in the product datasheets (Power Dissipation).

R<sub>ESR</sub> = the capacitor equivalent series resistance at the specified frequency

 AC Ripple Voltage: the maximum allowable ripple voltage shall be determined from the formula:

$$V_{RMS} = I_{RMS} \times Z$$

or, from the formula:

$$V_{RMS} = Z \sqrt{\frac{P}{R_{ESR}}}$$

where.

P = power dissipation in W at +25 °C as given in the tables in the product datasheets (Power Dissipation).

R<sub>ESR</sub> = the capacitor equivalent series resistance at the specified frequency

Z = the capacitor impedance at the specified frequency

- 2.1 The sum of the peak AC voltage plus the applied DC voltage shall not exceed the DC voltage rating of the capacitor.
- 2.2 The sum of the negative peak AC voltage plus the applied DC voltage shall not allow a voltage reversal exceeding 10 % of the DC working voltage at \$25 °C\$
- Reverse Voltage: solid tantalum capacitors are not intended for use with reverse voltage applied. However, they have been shown to be capable of withstanding momentary reverse voltage peaks of up to 10 % of the DC rating at 25 °C and 5 % of the DC rating at +85 °C.
- 4. Temperature Derating: if these capacitors are to be operated at temperatures above +25 °C, the permissible RMS ripple current shall be calculated using the derating factors as shown:

TEMPERATURE (°C)	DERATING FACTOR
+25	1.0
+85	0.9
+125	0.4
+150 <sup>(1)</sup>	0.3
+175 <sup>(1)</sup>	0.2
+200 <sup>(1)</sup>	0.1

#### Note

(1) Applicable for dedicated high temperature product series

5. **Power Dissipation:** power dissipation will be affected by the heat sinking capability of the mounting surface. Non-sinusoidal ripple current may produce heating effects which differ from those shown. It is important that the equivalent I<sub>BMS</sub> value

be established when calculating permissible operating levels. (Power dissipation calculated using +25 °C temperature rise).

6. **Printed Circuit Board Materials:** molded capacitors are compatible with commonly used printed circuit board materials (alumina substrates, FR4, FR5, G10, PTFE-fluorocarbon and porcelanized steel).

#### 7. Attachment:

- 7.1 **Solder Paste:** the recommended thickness of the solder paste after application is 0.007" ± 0.001" [0.178 mm ± 0.025 mm]. Care should be exercised in selecting the solder paste. The metal purity should be as high as practical. The flux (in the paste) must be active enough to remove the oxides formed on the metallization prior to the exposure to soldering heat. In practice this can be aided by extending the solder preheat time at temperatures below the liquidous state of the solder.
- 7.2 **Soldering:** capacitors can be attached by conventional soldering techniques; vapor phase, convection reflow, infrared reflow, wave soldering, and hot plate methods. The soldering profile charts show recommended time / temperature conditions for soldering. Preheating is recommended. The recommended maximum ramp rate is 3 °C per second. Attachment with a soldering iron is not recommended due to the difficulty of controlling temperature and time at temperature. The soldering iron must never come in contact with the capacitor. For details see <a href="https://www.vishay.com/doc?40214">www.vishay.com/doc?40214</a>.
- 7.2.1 Backward and Forward Compatibility: capacitors with SnPb or 100 % tin termination finishes can be soldered using SnPb or lead (Pb)-free soldering processes.
- 8. Cleaning (Flux Removal) After Soldering: molded capacitors are compatible with all commonly used solvents such as TES, TMS, Prelete, Chlorethane, Terpene and aqueous cleaning media. However, CFC / ODS products are not used in the production of these devices and are not recommended. Solvents containing methylene chloride or other epoxy solvents should be avoided since these will attack the epoxy encapsulation material.
- 8.1 When using ultrasonic cleaning, the board may resonate if the output power is too high. This vibration can cause cracking or a decrease in the adherence of the termination. DO NOT EXCEED 9W/I at 40 kHz for 2 min.
- 9. Recommended Mounting Pad Geometries: proper mounting pad geometries are essential for successful solder connections. These dimensions are highly process sensitive and should be designed to minimize component rework due to unacceptable solder joints. The dimensional configurations shown are the recommended pad geometries for both wave and reflow soldering techniques. These dimensions are intended to be a starting point for circuit board designers and may be fine tuned if necessary based upon the peculiarities of the soldering process and / or circuit board design.

# **Typical Performance Characteristics**

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# **TH5 Tantalum Capacitors**

ELECTRICAL PERFOR	ELECTRICAL PERFORMANCE CHARACTERISTICS			
ITEM	PERFORMANCE CHARACTERISTICS			
Category temperature range	-55 °C to +200 °C			
Category voltage	Category voltage is the same within entire temperature range and is equal to rated voltage			
Capacitance tolerance	± 20 %, ± 10 %, tested via bridge method, at 25 °C, 120 Hz			
Dissipation factor	Limits per Standard Ratings table. Tested via bridge method, at 25 °C, 120 Hz			
ESR	Limits per Standard Ratings table. Tested via bridge method, at 25 °C, 100 kHz			
Leakage current	After application of rated voltage applied to capacitors for 5 min using a steady source of power with 1 k $\Omega$ resistor in series with the capacitor under test, leakage current at 25 °C is not more than described in Standard Ratings table. Note that the leakage current varies with temperature and applied voltage.			

ENVIRONMENTAL PERFORMANCE CHARACTERISTICS			
ITEM	CONDITION	POST TEST PERFORMANCE	
Life test	500 h application of rated voltage at 200 °C	Capacitance change Dissipation factor ESR Leakage current	-30 % / +10 % of initially specified value Not to exceed 150 % of initial Not to exceed 125 % of initial Not to exceed 1 mA (at 200 °C)
Moisture resistance	Cycled, 20 cycles, MIL-STD-202, method 106	Capacitance change Dissipation factor Leakage current	± 15 % of initially specified value Not to exceed 150 % of initial Not to exceed 200 % of initial
Surge voltage	85 °C, 1000 cycles at 1.3 rated voltage in series with 33 $\Omega$ resistor, MIL-PRF-55365	Capacitance change Dissipation factor Leakage current	± 5 % of initially specified value Initial specified value or less Initial specified value or less

#### Note

All measurements to be performed after 24 h conditioning at room temperature

MECHANICAL PERFORMANCE CHARACTERISTICS			
ITEM	CONDITION	POST TEST PERFORMANCE	
Terminal strength / Shear force test	Apply a pressure load of 17.7 N for 60 s horizontally to the center of capacitor side body.	Capacitance change Within ± 10 % of initial value Dissipation factor Initial specified limit Leakage current Initial specified limit	
		There shall be no mechanical or visual damage to capacitors post-conditioning.	
Vibration	MIL-STD-202, method 204, condition D, 10 Hz to 2000 Hz, 20 <i>g</i> peak	There shall be no mechanical or visual damage and the components shall meet the original electrical requirements	
Resistance to solder heat	MIL-STD-202, method 210, condition K	Capacitance change ± 5 % of initially specified value Dissipation factor Initial specified value or less Leakage current Initial specified value or less	
		There shall be no mechanical or visual damage to capacitors post-conditioning.	
Solderability	MIL-STD-202, method 208, ANSI / J-STD-002, test B Applies only to solder and tin plated terminations. Does not apply to gold terminations.	All terminations shall exhibit a continuous solder coating free from defects for a minimum of 95 % of the critical area of any individual termination	
Resistance to solvents	MIL-STD-202, method 215	Marking has to remain legible, no degradation of encapsulation material	
Flammability	Encapsulation materials meet UL 94 V-0 with an oxygen index of 32 %		

#### Note

• All measurements to be performed after 24 h conditioning at room temperature



### **Legal Disclaimer Notice**

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#### **Disclaimer**

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